

## 500mA 2.4MHz Low $I_Q$ High Efficiency Synchronous Buck Converter

The ISL9103, ISL9103A is a 500mA, 2.4MHz step-down regulator, which is ideal for powering low-voltage microprocessors in compact devices such as PDAs and cellular phones. It is optimized for generating low output voltages down to 0.8V. The supply voltage range is from 2.7V to 6V allowing the use of a single Li+ cell, three NiMH cells or a regulated 5V input. It has guaranteed minimum output current of 500mA. A high switching frequency of 2.4MHz pulse-width modulation (PWM) allows using small external components. Under light load condition, the device operates at low  $I_Q$  skip mode with typical 20 $\mu$ A quiescent current for highest light load efficiency to maximize battery life, and it automatically switches to fixed frequency PWM mode under heavy load condition.

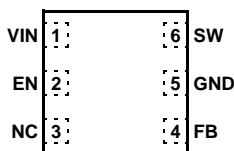
The ISL9103, ISL9103A includes a pair of low ON-resistance P-Channel and N-Channel internal MOSFETs to maximize system efficiency and minimize the external component count. 100% duty-cycle operation allows less than 300mV dropout voltage at 500mA.

The ISL9103, ISL9103A offers internal digital soft-start, enable for power sequence, overcurrent protection and thermal shutdown functions. In addition, the ISL9103, ISL9103A offers a quick bleeding function that discharges the output capacitor when the IC is disabled.

The ISL9103, ISL9103A is offered in a 1.6x1.6mm  $\mu$ TDFN package. The complete converter occupies less than 0.5cm<sup>2</sup>.

## Pinout

**ISL9103, ISL9103A**  
**(6 LD 1.6x1.6  $\mu$ TDFN)**  
TOP VIEW



## Features

- High Efficiency Integrated Synchronous Buck Regulator with up to 95% Efficiency
- 2.7V to 6.0V Supply Voltage
- 2.4MHz PWM Switching Frequency
- 500mA Guaranteed Output Current
- 3% Output Accuracy Over-Temperature and Line for Fixed Output Options
- 20 $\mu$ A Quiescent Supply Current in Skip Mode
- Less than 1 $\mu$ A Logic Controlled Shutdown Current
- 100% Maximum Duty Cycle for Lowest Dropout
- Ultrasonic Switching Frequency at Skip Mode to Prevent Audible Frequency Noise (For ISL9103A Only)
- Discharge Output Capacitor when Disabled
- Internal Digital Soft-Start
- Peak Current Limiting, Short Circuit Protection
- Over-Temperature Protection
- Chip Enable
- Small 6 Pin 1.6mmx1.6mm  $\mu$ TDFN Package
- Pb-Free (RoHS Compliant)

## Applications

- Single Li-ion Battery-Powered Equipment
- Mobile Phones and MP3 Players
- PDAs and Palmtops
- WCDMA Handsets
- Portable Instruments

## Pin Descriptions

PIN NUMBER	PIN NAME	DESCRIPTION
1	VIN	Input supply voltage. Typically connect a 10 $\mu$ F ceramic capacitor to ground.
2	EN	Regulator enable pin. Enable the device when driven to high. Shut down the chip and discharge output capacitor when driven to low. Do not leave this pin floating.
3	NC	No connect; leave floating.
4	FB	Buck converter output feedback pin. For adjustable output version, its typical value is 0.8V and connect it to the output through a resistor divider for desired output voltage; for fixed output version, directly connect this pin to the converter output.
5	GND	Ground connection.
6	SW	Switching node connection. Connect to one terminal of inductor.

## Ordering Information

PART NUMBER (Notes 1, 3, 4)	PART MARKING	OUTPUT VOLTAGE (V) (Note 2)	TEMP RANGE (°C)	PACKAGE Tape and Reel (Pb-Free)	PKG DWG. #	ULTRASONIC FUNCTION
ISL9103IRUNZ-T	J0	3.3	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	NO
ISL9103IRUJZ-T	J1	2.8	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	NO
ISL9103IRUFZ-T	J2	2.5	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	NO
ISL9103IRUDZ-T	J3	2.0	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	NO
ISL9103IRUCZ-T	J4	1.8	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	NO
ISL9103IRUBZ-T	J5	1.5	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	NO
ISL9103IRUWZ-T	J6	1.2	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	NO
ISL9103IRUAZ-T	J7	ADJ	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	NO
ISL9103AIRUNZ-T	J8	3.3	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	YES
ISL9103AIRUJZ-T	J9	2.8	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	YES
ISL9103AIRUFZ-T	K0	2.5	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	YES
ISL9103AIRUDZ-T	K1	2.0	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	YES
ISL9103AIRUCZ-T	K2	1.8	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	YES
ISL9103AIRUBZ-T	K3	1.5	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	YES
ISL9103AIRUWZ-T	K4	1.2	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	YES
ISL9103AIRUAZ-T	K5	ADJ	-40 to +85	6 Ld $\mu$ TDFN	L6.1.6x1.6	YES

### NOTES:

1. Please refer to [TB347](#) for details on reel specifications.
2. Other output voltage options may be available upon request, please contact Intersil for more details.
3. These Intersil Pb-free plastic packaged products employ special Pb-free material sets; molding compounds/die attach materials and NiPdAu plate - e4 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
4. For Moisture Sensitivity Level (MSL), please see device information page for [ISL9103, ISL9103A](#). For more information on MSL please see techbrief [TB363](#).

## Absolute Maximum Ratings

VIN, EN to GND	-0.3V to 6.5V
SW to GND	-1.5V to 6.5V
FB to GND (for adjustable version)	-0.3V to 2.7V
FB to GND (for fixed output version)	-0.3V to 3.6V

## Recommended Operating Conditions

VIN Supply Voltage Range	2.7V to 6.0V
Load Current	up to 500mA
Ambient Temperature Range	-40°C to +85°C

## Thermal Information

Thermal Resistance (Typical, Note 5)	$\theta_{JA}$ (°C/W)
6 Ld 1.6x1.6 $\mu$ TDFN Package	160
Junction Temperature Range	-40°C to +125°C
Storage Temperature Range	-65°C to +150°C
Pb-free Reflow Profile	see link below
<a href="http://www.intersil.com/pbfree/Pb-FreeReflow.asp">http://www.intersil.com/pbfree/Pb-FreeReflow.asp</a>	

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

## NOTE:

5.  $\theta_{JA}$  is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief TB379 for details.

## Electrical Specifications

Unless otherwise noted, all parameter limits are guaranteed over the recommended operating conditions and the typical specifications are measured at the following conditions:  $T_A = +25^\circ\text{C}$ ,  $V_{IN} = V_{EN} = 3.6\text{V}$ ,  $L = 2.2\mu\text{H}$ ,  $C_1 = 10\mu\text{F}$ ,  $C_2 = 10\mu\text{F}$ ,  $I_{OUT} = 0\text{A}$  (see "Typical Applications" on page 8). **Boldface limits apply over the operating temperature range, -40°C to +85°C.**

PARAMETER	SYMBOL	TEST CONDITIONS	MIN (Note6)	TYP	MAX (Note 6)	UNITS
<b>SUPPLY</b>						
Undervoltage Lockout Threshold (UVLO)	$V_{UVLO}$	$T_A = +25^\circ\text{C}$ , Rising	-	2.5	2.7	V
UVLO Hysteresis			<b>50</b>	150	-	mV
Quiescent Supply Current (for ISL9103 Adjustable Output Voltage Only)	$I_{VIN1}$	In skip mode, no load at the output, no switch, $V_{IN} = 6.0\text{V}$	-	20	<b>34</b>	$\mu\text{A}$
Quiescent Supply Current (for ISL9103A Adjustable Output Only)	$I_{VIN2}$	In skip mode, no load at the output, no switch, $V_{IN} = 6.0\text{V}$	-	32	<b>45</b>	$\mu\text{A}$
Shut Down Supply Current	$I_{SD}$	$V_{IN} = 6.0\text{V}$ , EN = LOW	-	0.05	<b>1</b>	$\mu\text{A}$
<b>OUTPUT REGULATION</b>						
FB Voltage Accuracy (for Adjustable Output Only)		$T_A = 0^\circ\text{C}$ to $+85^\circ\text{C}$	<b>-2</b>	-	<b>+2</b>	%
			<b>-2.5</b>	-	<b>+2.5</b>	%
FB Voltage	$V_{FB}$			0.8		V
FB Bias Current (for Adjustable Output Only)	$I_{FB}$	$V_{FB} = 0.75\text{V}$	-	5	<b>100</b>	nA
Output Voltage Accuracy (for Fixed Output Voltage Only)		PWM Mode	<b>-3</b>	-	<b>3</b>	%
Line Regulation		$V_{IN} = V_O + 0.5\text{V}$ to 6V (minimal 2.7V)	-	0.2	-	%/V
Load Regulation		$V_{IN} = 3.6\text{V}$ , $I_O = 150\text{mA}$ to 500mA	-	0.0009	-	%/mA
<b>SW</b>						
P-Channel MOSFET ON-Resistance		$V_{IN} = 3.6\text{V}$ , $I_O = 200\text{mA}$	-	0.45	<b>0.6</b>	$\Omega$
		$V_{IN} = 2.7\text{V}$ , $I_O = 200\text{mA}$	-	0.55	<b>0.72</b>	$\Omega$
N-Channel MOSFET ON-Resistance		$V_{IN} = 3.6\text{V}$ , $I_O = 200\text{mA}$	-	0.4	<b>0.52</b>	$\Omega$
		$V_{IN} = 2.7\text{V}$ , $I_O = 200\text{mA}$	-	0.5	<b>0.65</b>	$\Omega$
N-Channel Bleeding MOSFET ON-Resistance			-	100	-	$\Omega$
P-Channel MOSFET Peak Current Limit	$I_{PK}$	$V_{IN} = 4.2\text{V}$	<b>0.7</b>	0.95	<b>1.30</b>	A
Maximum Duty Cycle			-	100	-	%
SW Leakage Current		SW at Hi-Z state	-	0.01	<b>2</b>	$\mu\text{A}$
PWM Switching Frequency	$f_S$	$V_{IN} = 3.6\text{V}$	<b>1.9</b>	2.4	<b>2.75</b>	MHz

## Electrical Specifications

Unless otherwise noted, all parameter limits are guaranteed over the recommended operating conditions and the typical specifications are measured at the following conditions:  $T_A = +25^\circ\text{C}$ ,  $V_{IN} = V_{EN} = 3.6\text{V}$ ,  $L = 2.2\mu\text{H}$ ,  $C_1 = 10\mu\text{F}$ ,  $C_2 = 10\mu\text{F}$ ,  $I_{OUT} = 0\text{A}$  (see "Typical Applications" on page 8). **Boldface limits apply over the operating temperature range,  $-40^\circ\text{C}$  to  $+85^\circ\text{C}$ .** (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN (Note6)	TYP	MAX (Note 6)	UNITS
SW Minimum On-Time			-	65	-	ns
Soft-Start-Up Time			-	1.2	-	ms
<b>EN</b>						
Logic Input Low			-	-	<b>0.4</b>	V
Logic Input High			<b>1.4</b>	-	-	V
Logic Input Leakage Current			-	0.1	<b>1</b>	$\mu\text{A}$
Thermal Shutdown			-	130	-	$^\circ\text{C}$
Thermal Shutdown Hysteresis			-	30	-	$^\circ\text{C}$

NOTE:

- Parameters with MIN and/or MAX limits are 100% tested at  $+25^\circ\text{C}$ , unless otherwise specified. Temperature limits established by characterization and are not production tested

## Typical Operating Performance

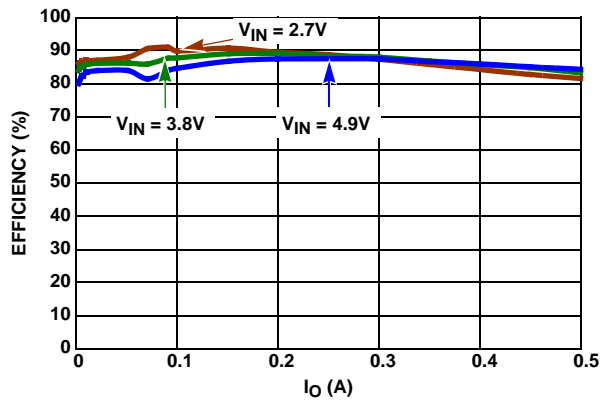


FIGURE 1. EFFICIENCY vs LOAD CURRENT ( $V_O = 1.5\text{V}$ )

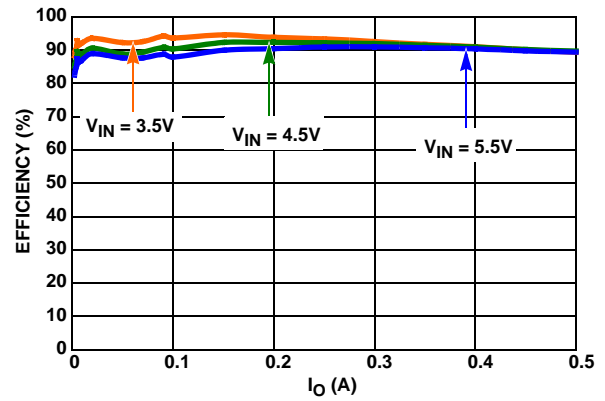


FIGURE 2. EFFICIENCY vs LOAD CURRENT ( $V_O = 2.5\text{V}$ )

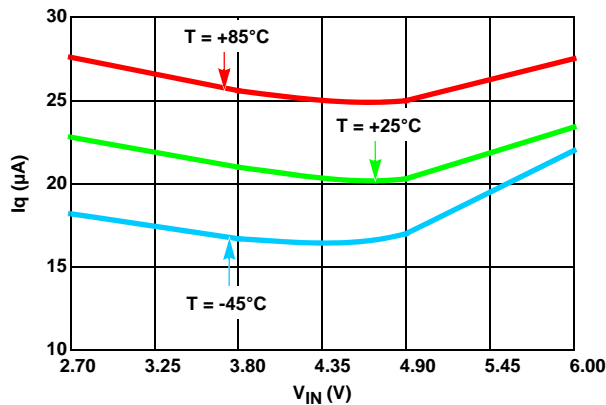


FIGURE 3. INPUT QUIESCENT CURRENT vs  $V_{IN}$  ( $V_O = 2.5\text{V}$ )

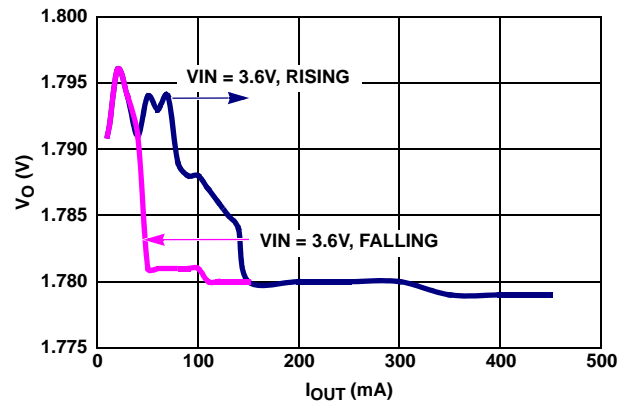


FIGURE 4. OUTPUT VOLTAGE vs LOAD CURRENT  
(ISL9103,  $V_{O\_NOMINAL} = 1.8\text{V}$ )

Typical Operating Performance (Continued)

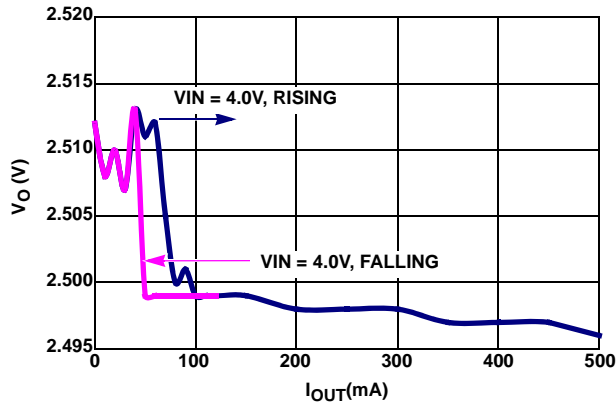


FIGURE 5. OUTPUT VOLTAGE vs LOAD CURRENT (ISL9103,  $V_{O\_NOMINAL} = 2.5V$ )

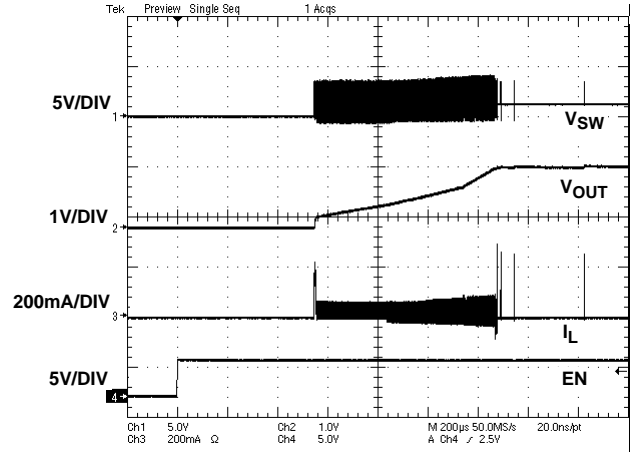


FIGURE 6. SOFT-START TO PFM MODE ( $V_{IN} = 3.6V$ ,  $V_{OUT} = 1.5V$ ,  $I_{OUT} = 0.001mA$ )

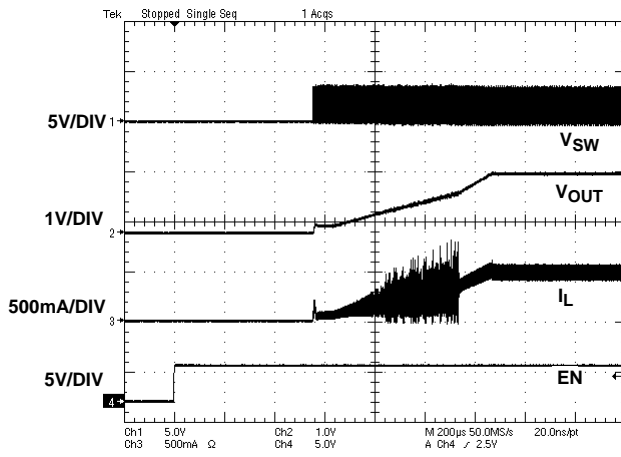


FIGURE 7. SOFT-START TO PWM MODE ( $V_{IN} = 3.6V$ ,  $V_{OUT} = 1.5V$ ,  $I_{OUT} = 500mA$ )

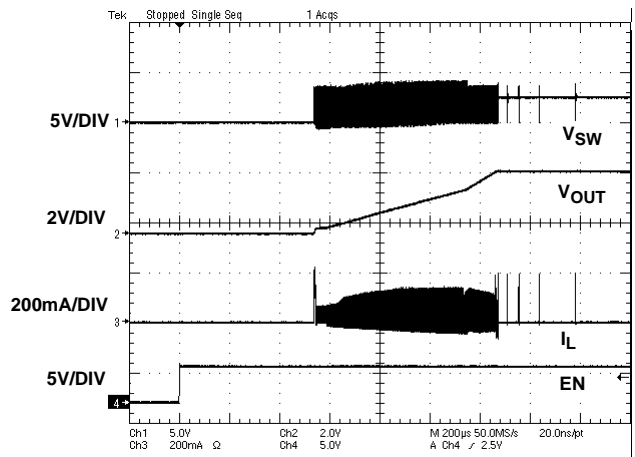


FIGURE 8. SOFT-START TO PFM MODE ( $V_{IN} = 3.6V$ ,  $V_{OUT} = 2.5V$ ,  $I_{OUT} = 0.001mA$ )

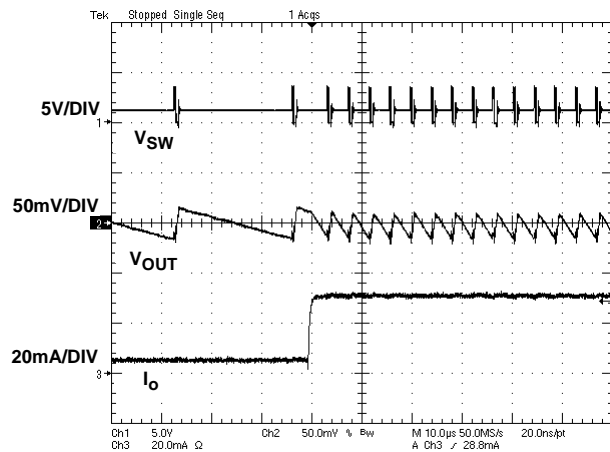


FIGURE 9. LOAD TRANSIENT IN PFM MODE ( $V_{IN} = 3.6V$ ,  $V_{OUT} = 1.5V$ , 5mA TO 30mA)

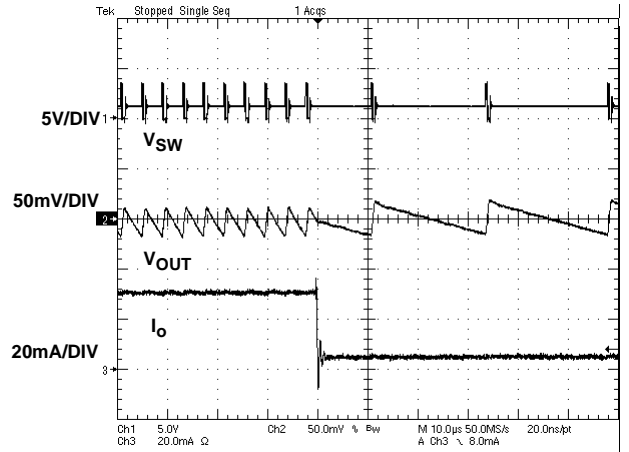


FIGURE 10. LOAD TRANSIENT IN PFM MODE ( $V_{IN} = 3.6V$ ,  $V_{OUT} = 1.5V$ , 30mA TO 5mA)

## Typical Operating Performance (Continued)

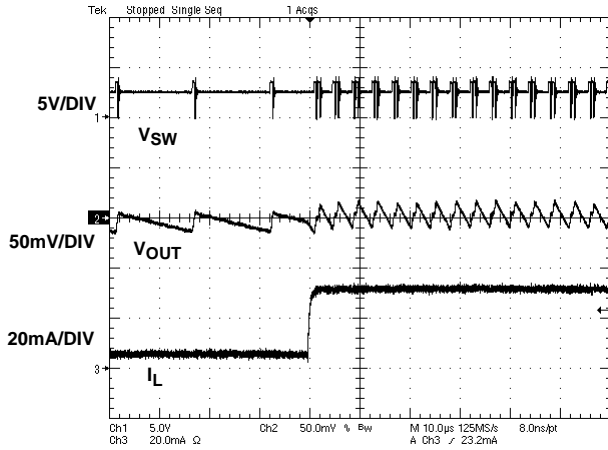


FIGURE 11. LOAD TRANSIENT IN PFM MODE ( $V_{IN} = 3.6V$ ,  $V_{OUT} = 2.5V$ , 5mA TO 30mA)

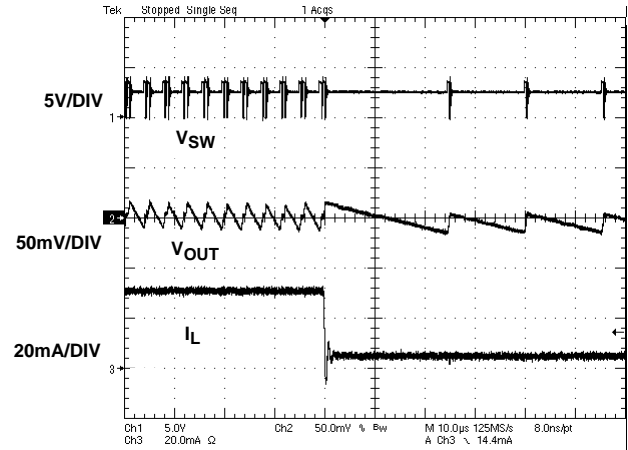


FIGURE 12. LOAD TRANSIENT IN PFM MODE ( $V_{IN} = 3.6V$ ,  $V_{OUT} = 2.5V$ , 30mA TO 5mA)

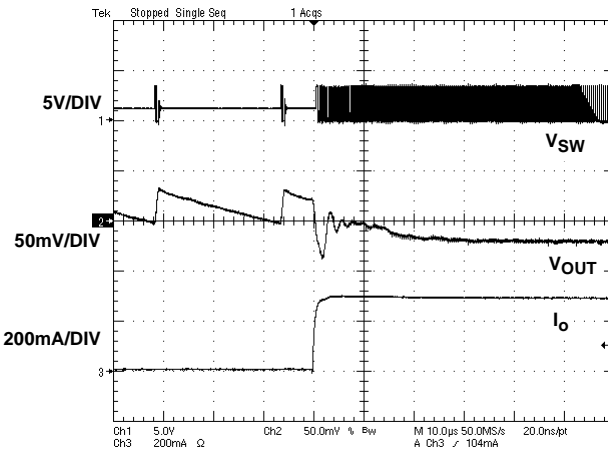


FIGURE 13. LOAD TRANSIENT FROM PFM TO PWM MODE ( $V_{IN} = 3.6V$ ,  $V_{OUT} = 1.5V$ , 5mA TO 300mA)

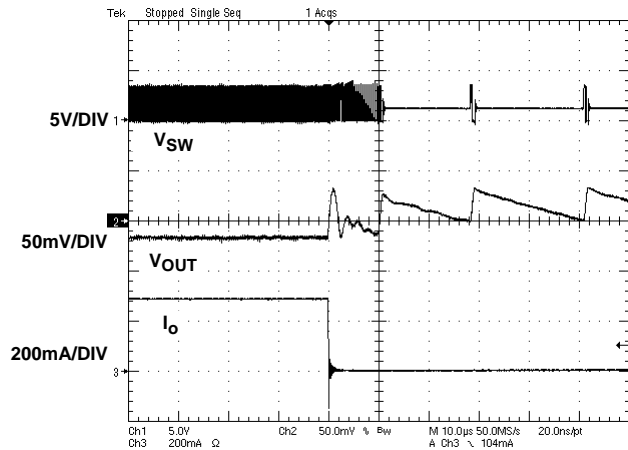


FIGURE 14. LOAD TRANSIENT FROM PWM TO PFM MODE ( $V_{IN} = 3.6V$ ,  $V_{OUT} = 1.5V$ , 300mA TO 5mA)

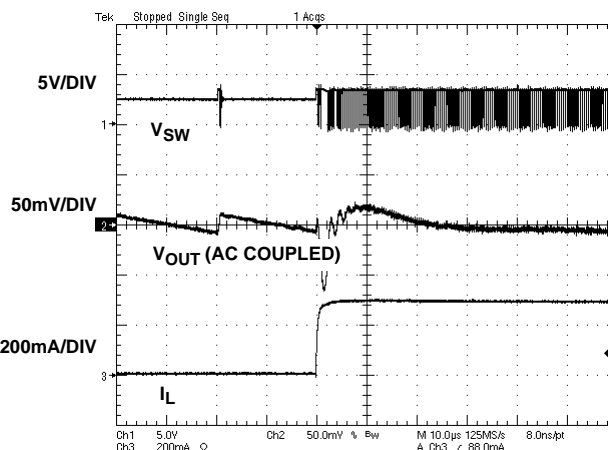


FIGURE 15. LOAD TRANSIENT FROM PFM TO PWM MODE ( $V_{IN} = 3.6V$ ,  $V_{OUT} = 2.5V$ , 5mA TO 300mA)

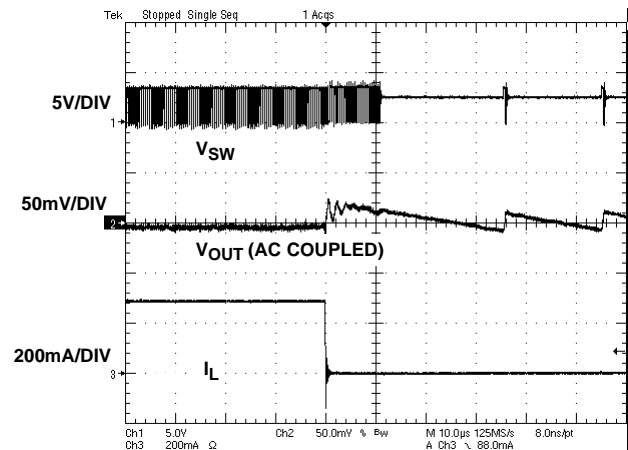
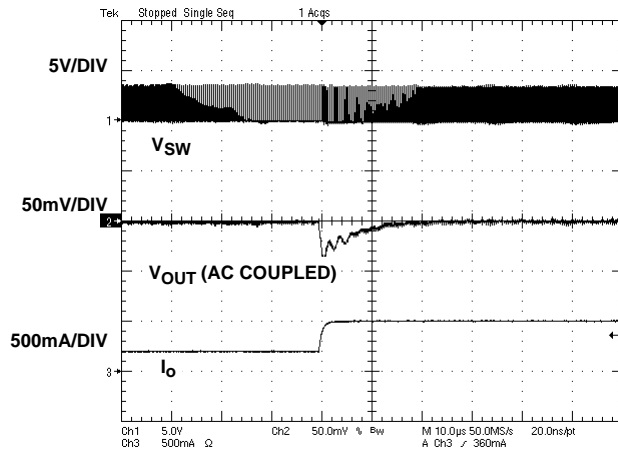
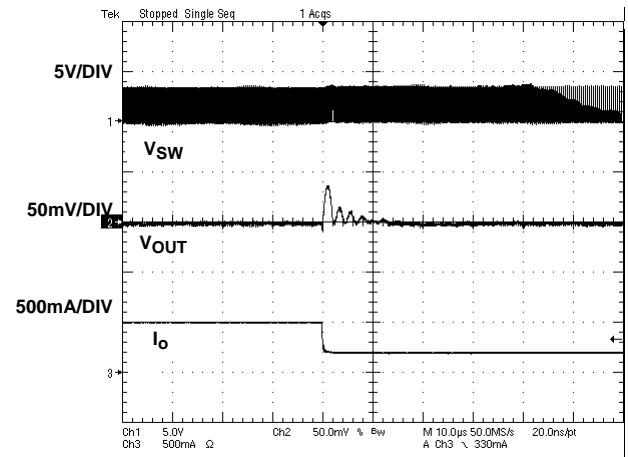
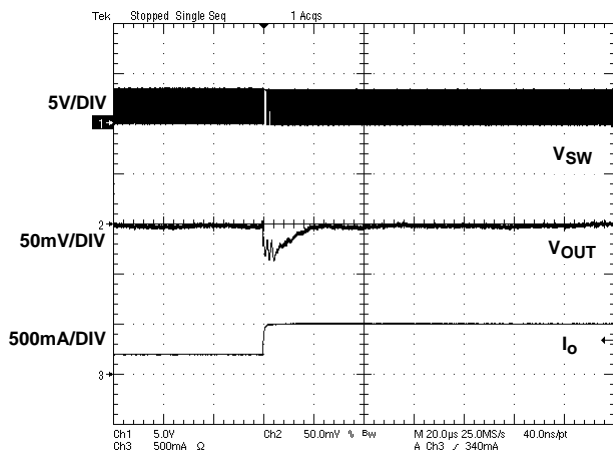
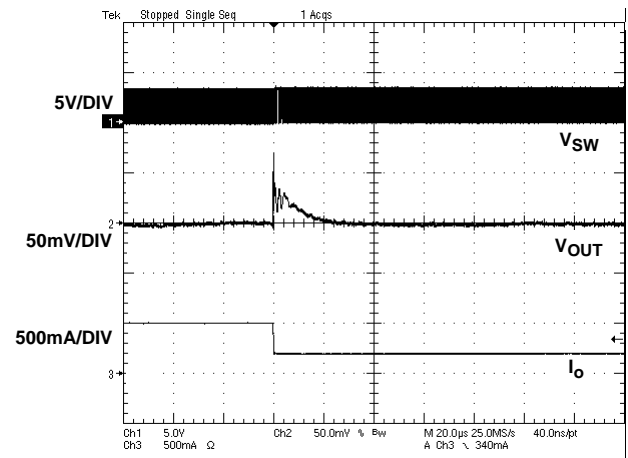


FIGURE 16. LOAD TRANSIENT FROM PWM TO PFM MODE ( $V_{IN} = 3.6V$ ,  $V_{OUT} = 2.5V$ , 300mA TO 5mA)

## Typical Operating Performance (Continued)

FIGURE 17. LOAD TRANSIENT IN PWM MODE ( $V_{IN} = 3.6V$ ,  $V_O = 1.5V$ , 200mA TO 500mA)FIGURE 18. LOAD TRANSIENT IN PWM MODE ( $V_{IN} = 3.6V$ ,  $V_O = 1.5V$ , 500mA TO 200mA)FIGURE 19. LOAD TRANSIENT IN PWM MODE ( $V_{IN} = 3.6V$ ,  $V_O = 2.5V$ , 200mA TO 500mA)FIGURE 20. LOAD TRANSIENT IN PWM MODE ( $V_{IN} = 3.6V$ ,  $V_O = 2.5V$ , 500mA TO 200mA)

## Typical Applications

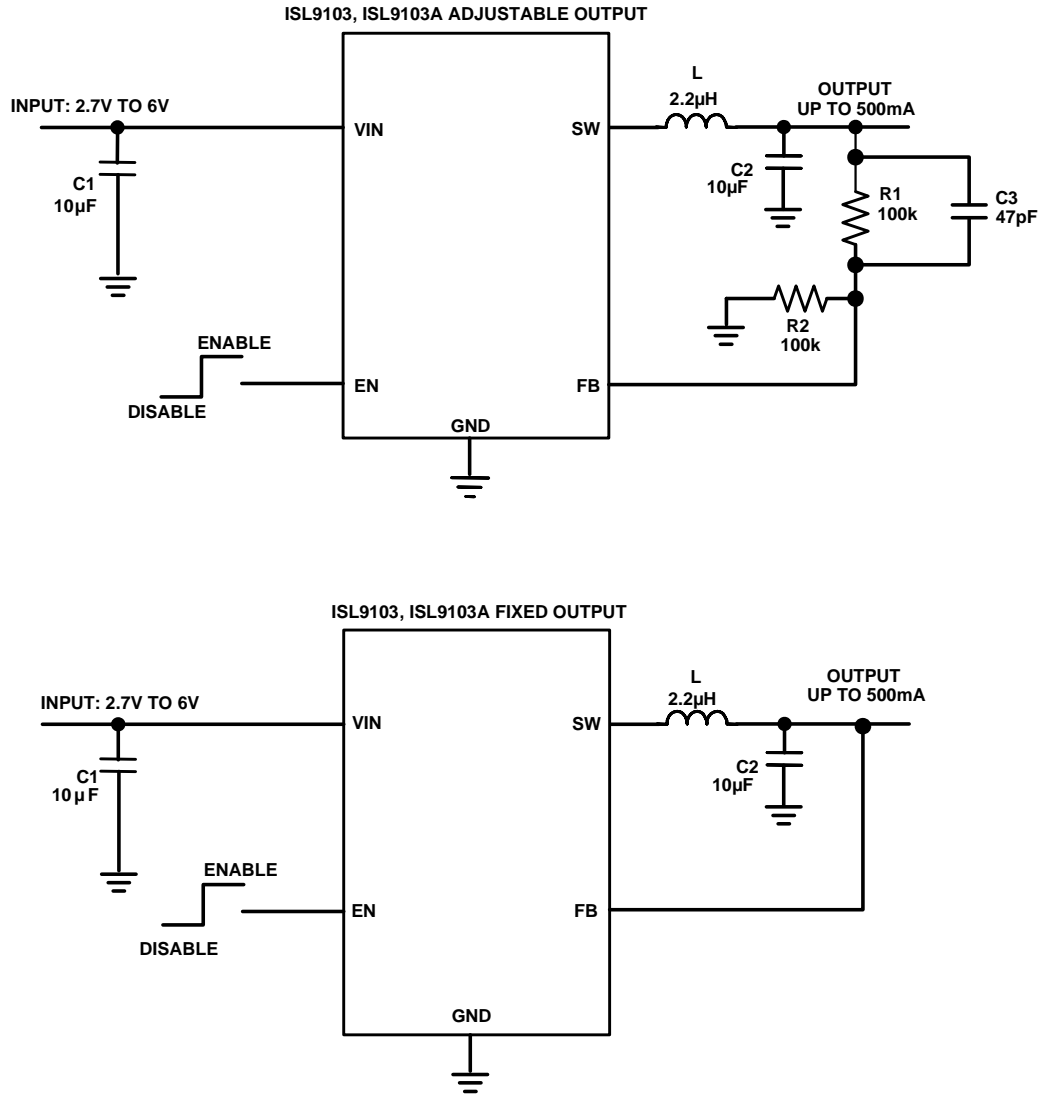


FIGURE 21. TYPICAL APPLICATIONS DIAGRAM

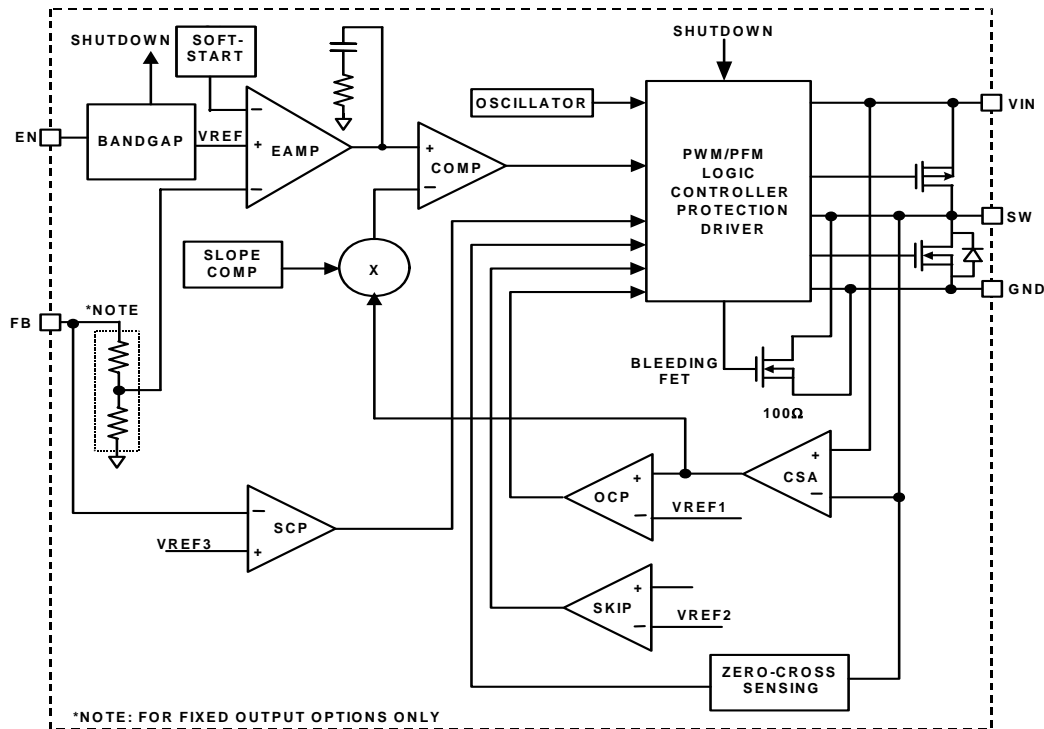
Note: For adjustable output version, the internal feedback resistor divider is disabled and the FB pin is directly connected to the error amplifier.

TABLE 1. BILL OF MATERIALS

PARTS	DESCRIPTION	MANUFACTURERS	PART NUMBER	SPECIFICATIONS	SIZE
L	Inductor	Sumida	CDRH2D14NP-2R2NC	2.2µH	3.2mmx3.2mm
C1, C2	Input and output capacitor	Panasonic	ECJ-1VB1A106M	10µF/10V, X5R	0603
C3	Capacitor	KEMET	C0402C470J5GACTU	47pF/50V	0402
R1, R2	Resistor	Various	-	100kΩ, SMD, 1%	0402



## Block Diagram



NOTE: For Adjustable output version, the internal feedback resistor divider is disabled and the FB pin is directly connected to the error amplifier.

FIGURE 22. FUNCTIONAL BLOCK DIAGRAM

## Theory of Operation

The ISL9103, ISL9103A is a step-down switching regulator optimized for battery-powered handheld applications. The regulator operates at typical 2.4MHz fixed switching frequency under heavy load condition to allow small external inductor and capacitors to be used for minimal printed-circuit board (PCB) area. At light load, the regulator can automatically enter the skip mode (PFM mode) to reduce the switching frequency to minimize the switching loss and to maximize the battery life. The quiescent current under skip mode, and under no load and no switch condition is typically only 20μA. The supply current is typically only 0.05μA when the regulator is disabled.

### PWM Control Scheme

The ISL9103, ISL9103A uses the peak-current-mode pulse-width modulation (PWM) control scheme for fast transient response and pulse-by-pulse current limiting. Figure 22 shows the circuit functional block diagram. The current loop consists of the oscillator, the PWM comparator COMP, current sensing circuit, and the slope compensation for the current loop stability. The current sensing circuit consists of the resistance of the P-Channel MOSFET when it is turned on and the Current Sense Amplifier (CSA). The

control reference for the current loops comes from the Error Amplifier (EAMP) of the voltage loop.

The PWM operation is initialized by the clock from the oscillator. The P-Channel MOSFET is turned on at the beginning of a PWM cycle and the current in the P-Channel MOSFET starts ramping up. When the sum of the CSA output and the compensation slope reaches the control reference of the current loop, the PWM comparator COMP sends a signal to the PWM logic to turn off the P-Channel MOSFET and to turn on the N-Channel MOSFET. The N-MOSFET remains on till the end of the PWM cycle. Figure 23 shows the typical operating waveforms during the normal PWM operation. The dotted lines illustrate the sum of the slope compensation ramp and the CSA output.

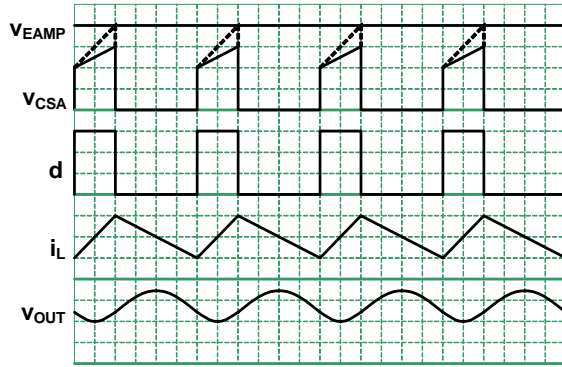


FIGURE 23. PWM OPERATION WAVEFORMS

The output voltage is regulated by controlling the reference voltage to the current loop. The bandgap circuit outputs a 0.8V reference voltage to the voltage control loop. The feedback signal comes from the FB pin. The soft-start block only affects the operation during the start-up and will be discussed separately in “Soft-Start” on page 11. The EAMP is a transconductance amplifier, which converts the voltage error signal to a current output. The voltage loop is internally compensated by a RC network. The maximum EAMP voltage output is precisely clamped to the bandgap voltage.

### Skip Mode (PFM Mode)

Under light load condition, ISL9103, ISL9103A automatically enters a pulse-skipping mode to minimize the switching loss by reducing the switching frequency. Figure 24 illustrates the skip mode operation. A zero-cross sensing circuit (as shown in Figure 22) monitors the current flowing through SW node for zero crossing. When it is detected to cross zero for 16-consecutive cycles, the regulator enters the skip mode.

During the 16-consecutive cycles, the inductor current could be negative. The counter is reset to zero when the sensed current flowing through SW node does not cross zero during any cycle within the 16-consecutive cycles. Once ISL9103, ISL9103A enters the skip mode, the pulse modulation starts being controlled by the SKIP comparator shown in Figure 22. Each pulse cycle is still synchronized by the PWM clock. The P-Channel MOSFET is turned on at the rising edge of clock and turned off when its current reaches ~20% of the peak current limit. As the average inductor current in each cycle is higher than the average current of the load, the output voltage rises cycle over cycle. When the output voltage is sensed to reach 1.5% above its nominal voltage, the P-Channel MOSFET is turned off immediately and the inductor current is fully discharged to zero and stays at zero. The output voltage reduces gradually due to the load current discharging the output capacitor. When the output voltage drops to the nominal voltage, the P-Channel MOSFET will be turned on again, repeating the previous operations.

The regulator resumes normal PWM mode operation when the output voltage is sensed to drop below 1.5% of its nominal voltage value.

### Enable

The enable (EN) pin allows user to enable or disable the converter for purposes such as power-up sequencing. With EN pin pulled to high, the converter is enabled and the internal reference circuit wakes up first and then the soft start-up begins. When EN pin is pulled to logic low, the converter is disabled, both P-Channel MOSFET and N-Channel MOSFETS are turned off, and the output capacitor is discharged through internal discharge path.

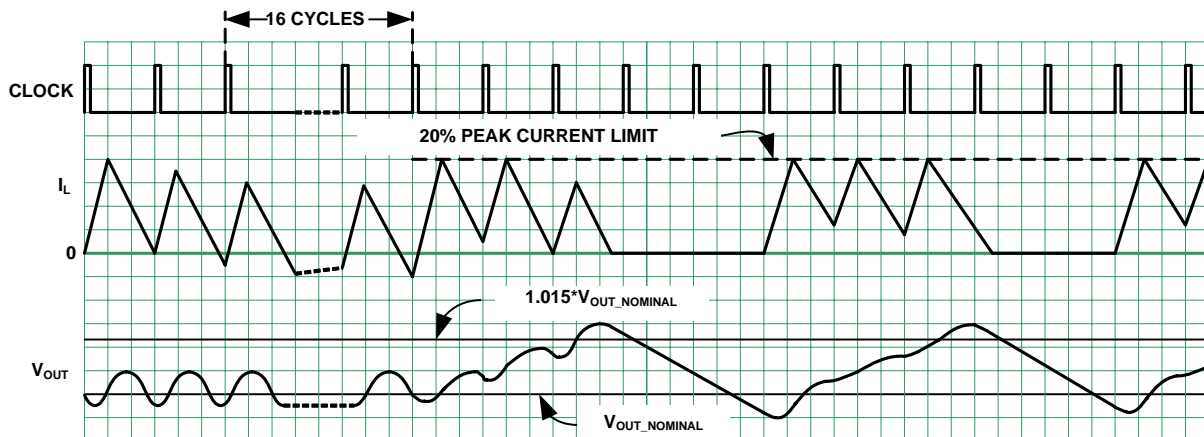


FIGURE 24. SKIP MODE OPERATION WAVEFORMS

## Overcurrent Protection

The overcurrent protection is provided on ISL9103, ISL9103A when overload condition happens. It is realized by monitoring the CSA output with the OCP comparator, as shown in Figure 22. When the current at P-Channel MOSFET is sensed to reach the current limit, the OCP comparator is triggered to turn off the P-Channel MOSFET immediately.

## Short-Circuit Protection

ISL9103, ISL9103A has a Short-Circuit Protection (SCP) comparator, which monitors the FB pin voltage for output short-circuit protection. When the output voltage is sensed to be lower than a certain threshold, the SCP comparator reduces the PWM oscillator frequency to a much lower frequency to protect the IC from being damaged.

## Undervoltage Lockout (UVLO)

When the input voltage is below the Undervoltage Lock Out (UVLO) threshold, ISL9103, ISL9103A is disabled.

## Soft-Start

The soft-start feature eliminates the inrush current during the circuit start-up. The soft-start block outputs a ramp reference to both the voltage loop and the current loop. The two ramps limit the inductor current rising speed as well as the output voltage speed so that the output voltage rises in a controlled fashion.

## Low Dropout Operation

The ISL9103, ISL9103A features low dropout operation to maximize the battery life. When the input voltage drops to a level that ISL9103, ISL9103A can no longer operate under switching regulation to maintain the output voltage, the P-Channel MOSFET is completely turned on (100% duty cycle). The dropout voltage under such condition is the product of the load current and the ON-resistance of the P-Channel MOSFET. Minimum required input voltage  $V_{IN}$  under this condition is the sum of output voltage plus the voltage drop across the inductor and the P-Channel MOSFET switch.

## Thermal Shut Down

The ISL9103, ISL9103A provides built-in thermal protection function. The thermal shutdown threshold temperature is +130°C (typ) with a 30°C (typ) hysteresis. When the internal temperature is sensed to reach +130°C, the regulator is completely shut down and as the temperature drops to +100°C (typ), the ISL9103, ISL9103A resumes operation starting from the soft-start.

## Applications Information

### Inductor and Output Capacitor Selection

To achieve better steady state and transient response, ISL9103, ISL9103A typically uses a 2.2μH inductor. The peak-to-peak inductor current ripple can be expressed in Equation 1:

$$\Delta I = \frac{V_O \cdot \left(1 - \frac{V_O}{V_{IN}}\right)}{L \cdot f_S} \quad (\text{EQ. 1})$$

In Equation 1, usually the typical values can be used but to have a more conservative estimation, the inductance should consider the value with worst case tolerance; and for switching frequency  $f_S$ , the minimum  $f_S$  from the “Electrical Specifications” table on page 3 can be used.

To select the inductor, its saturation current rating should be at least higher than the sum of the maximum output current and half of the delta calculated from Equation 1. Another more conservative approach is to select the inductor with the current rating higher than the P-Channel MOSFET peak current limit.

Another consideration is the inductor DC resistance since it directly affects the efficiency of the converter. Ideally, the inductor with the lower DC resistance should be considered to achieve higher efficiency.

Inductor specifications could be different from different manufacturers so please check with each manufacturer if additional information is needed.

For the output capacitor, a ceramic capacitor can be used because of the low ESR values, which helps to minimize the output voltage ripple. A typical value of 10μF ceramic capacitor should be enough for most of the applications and the capacitor should be X5R or X7R.

### Input Capacitor Selection

The main function for the input capacitor is to provide decoupling of the parasitic inductance and to provide filtering function to prevent the switching current from flowing back to the battery rail. A 10μF ceramic capacitor (X5R or X7R) is a good starting point for the input capacitor selection.

### Output Voltage Setting Resistor Selection

For ISL9103, ISL9103A adjustable output option, the voltage resistors,  $R_1$  and  $R_2$ , as shown in Figure 21, set the desired output voltage values. The output voltage can be calculated using Equation 2:

$$V_O = V_{FB} \cdot \left(1 + \frac{R_1}{R_2}\right) \quad (\text{EQ. 2})$$

where  $V_{FB}$  is the feedback voltage (typically it is 0.8V). The current flowing through the voltage divider resistors can be calculated as  $V_O/(R_1 + R_2)$ , so larger resistance is desirable to minimize this current. On the other hand, the FB pin has leakage current that will cause error in the output voltage setting. The leakage current has a typical value of 0.1μA. To minimize the accuracy impact on the output voltage, select the  $R_2$  no larger than 200kΩ.

For adjustable output versions, C3 (shown in Figure 21) is highly recommended for improving stability and achieving better transient response.

Table 2 provides the recommended component values for some output voltage options.

**TABLE 2. RECOMMENDED ISL9103, ISL9103A ADJUSTABLE OUTPUT VERSION CIRCUIT CONFIGURATION vs V<sub>OUT</sub>**

V <sub>OUT</sub> (V)	L (μH)	C2 (μF)	R1 (kΩ)	C3 (pF)	R2 (kΩ)
0.8	2.2	10	0	N/A	N/A
1.0	2.2	10	44.2	100	178
1.2	2.2	10	80.6	47	162
1.5	2.2	10	84.5	47	97.6
1.8	2.2	10	100	47	80.6
2.5	2.2	10	100	47	47.5
2.8	2.2	10	100	47	40.2
3.3	2.2	10	102	47	32.4

### Layout Recommendation

The PCB layout is a very important converter design step to make sure the designed converter works well, especially under the high current high switching frequency condition.

For ISL9103, ISL9103A, the power loop is composed of the output inductor L, the output capacitor C<sub>OUT</sub>, the SW pin and the PGND pin. It is necessary to make the power loop as small as possible and the connecting traces among them should be direct, short and wide; the same type of traces should be used to connect the VIN pin, the input capacitor C<sub>IN</sub> and its ground.

The switching node of the converter, the SW pin, and the traces connected to this node are very noisy, so keep the voltage feedback trace and other noise sensitive traces away from these noisy traces.

The input capacitor should be placed as close as possible to the VIN pin. The ground of the input and output capacitors should be connected as close as possible as well. In addition, a solid ground plane is helpful for EMI performance.

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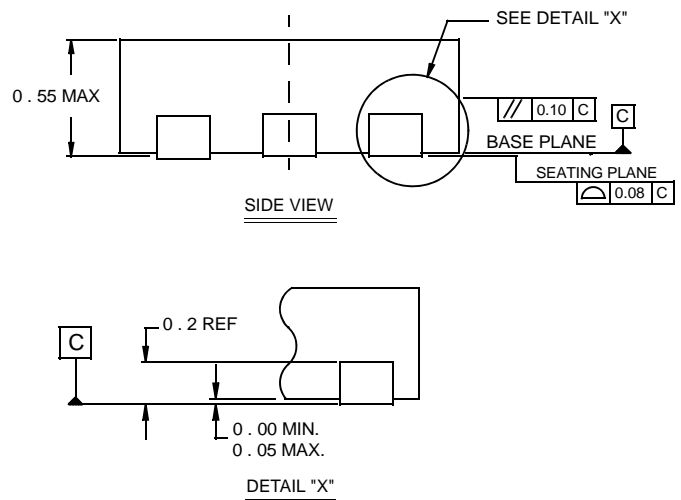
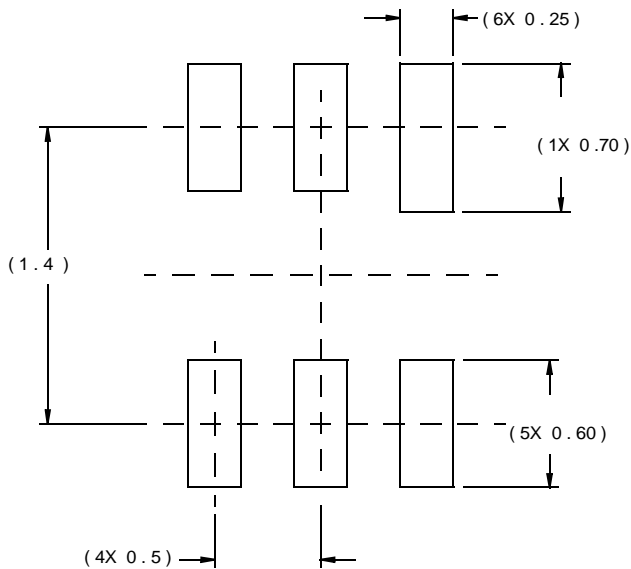
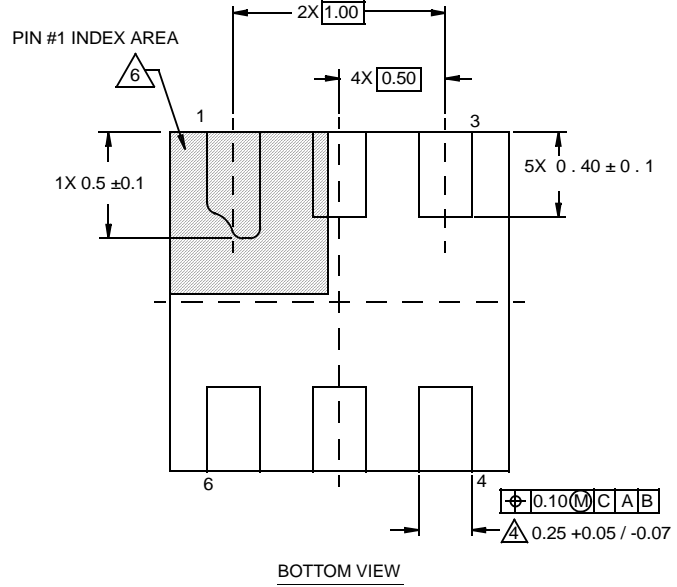
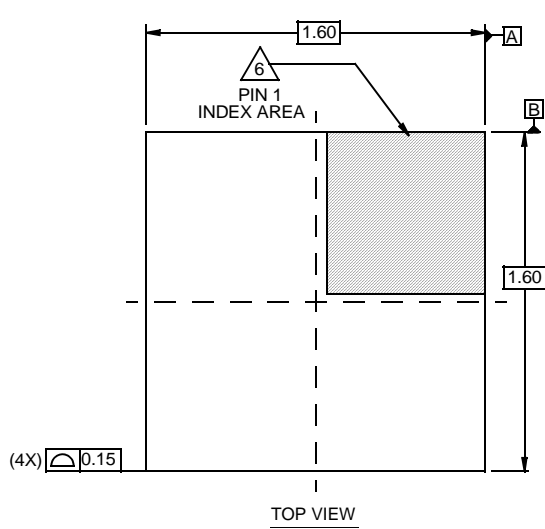
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# Package Outline Drawing

## L6.1.6x1.6

6 LEAD ULTRA THIN DUAL FLAT NO-LEAD COL PLASTIC PACKAGE (UTDFN COL)

Rev 1, 11/07



### NOTES:

1. Dimensions are in millimeters.  
Dimensions in ( ) for Reference Only.
2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal  $\pm 0.05$
4. Dimension b applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
5. Tiebar shown (if present) is a non-functional feature.
6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.